



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



100-MHz 32-bit RX MCU, on-chip FPU, 165 DMIPS, up to 2-MB flash memory, USB 2.0 full-speed function interface, CAN, 10- & 12-bit A/D converter, RTC, up to 22 comms interfaces

Features

■ 32-bit RX CPU core

- Max. operating frequency: 100 MHz
Capable of 165 DMIPS in operation at 100 MHz
- Single precision 32-bit IEEE-754 floating point
- Two types of multiply-and-accumulation unit (between memories and between registers)
- 32-bit multiplier (fastest instruction execution takes one CPU clock cycle)
- Divider (fastest instruction execution takes two CPU clock cycles)
- Fast interrupt
- CISC Harvard architecture with 5-stage pipeline
- Variable-length instructions: Ultra-compact code
- Supports the memory protection unit (MPU)
- Two types of debugging interfaces: JTAG and FINE (two-line)

■ Low-power design and architecture

- Operation from a single 2.7- to 3.6-V supply
- Low power consumption: A product that supports all peripheral functions draws only 500 μ A/MHz.
- RTC is capable of operation from a dedicated power supply (min. operating voltage: 2.3 V).
- Four low-power modes

■ On-chip main flash memory, no wait states

- 100-MHz operation, 10-ns read cycle (no wait states)
- 384-Kbyte to 2-Mbyte capacities
- User code is programmable by on-board or off-board programming.

■ On-chip data flash memory

- Max. 32 Kbytes, reprogrammable up to 100,000 times
- Programming/erasing as background operations (BGOs)

■ On-chip SRAM, no wait states

- 32- to 128-Kbyte capacities
- For instructions and operands
- Can provide backup on deep software standby

■ DMA

- DMAC: Incorporates four channels
- DTC

■ Reset and supply management

- Power-on reset (POR)
- Low voltage detection (LVD) with voltage settings

■ Clock functions

- External crystal oscillator or internal PLL for operation at 4 to 16 MHz
- Internal 125-kHz LOCO and 50-MHz HOCO
- 125-kHz clock for the IWDT
- Frequency of the oscillator for sub-clock generation: 32 kHz

■ Real-time clock

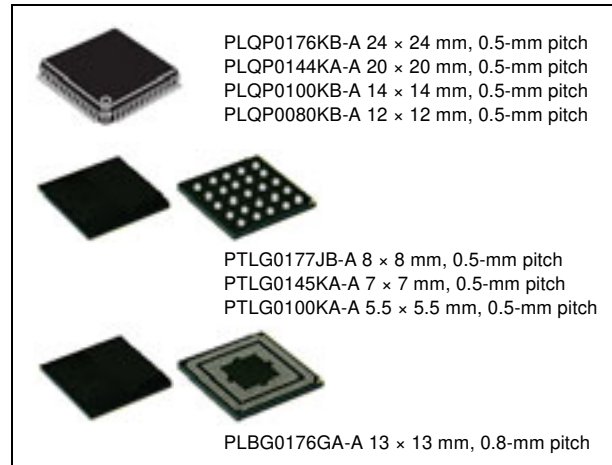
- Adjustment functions (30 seconds, leap year, and error)
- Time capture function
(for capturing times in response to event-signal input on external pins)

■ Independent watchdog timer

- 125-kHz LOCO clock operation

■ Useful functions for IEC60730 compliance

- Oscillation-stop detection, frequency measurement, CRC, IWDT, self-diagnostic function for the A/D converter, etc.



■ Up to 22 communications interfaces

- USB 2.0 full-speed function interface (1 channel)
- CAN (compliant with ISO11898-1), incorporating 32 mailboxes (up to 3 channels)
- SCI with multiple functionalities (up to 13 channels)
Choose from among asynchronous mode, clock-synchronous mode, smart-card interface mode, simple SPI, simple I²C, and extended serial mode.
- I²C bus interface for transfer at up to 1 Mbps (up to 4 channels)
- RSPI for high-speed transfer (up to 3 channels)

■ External address space

- 8 CS areas (8 × 16 Mbytes)
- Multiplexed address data or separate address lines are selectable per area.
- 8-, 16-, or 32-bit bus space is selectable per area

■ Up to 20 extended-function timers

- 16-bit MTU2: input capture, output capture, complementary PWM output, phase-counting mode (6 channels)
- 16-bit TPU: input capture, output capture, phase-counting mode (12 channels)
- 8-bit TMR (4 channels)
- 16-bit compare-match timers (4 channels)

■ A/D converter for 1-MHz operation

- Up to 21 12-bit channels, and incorporating 1 sample-and-hold circuit
- Up to 8 10-bit channels, and incorporating 1 sample-and-hold circuit
- Addition of results of A/D conversion (in the 12-bit A/D converter)
- self-diagnosis (for the 10-bit A/D converter)

■ 10-bit D/A converter: 2 channels

■ Temperature sensor for measuring temperature within the chip

■ Register write protection function can protect values in important registers against overwriting.

■ Up to 148 general I/O port pins for GPIO

- 5-V tolerance, open drain, input pull-up, switchable driving ability

■ Unique ID

- 16-byte ID code is provided for each chip (only for the G version)

■ Operating temp. range

- D version: -40 to +85°C
- G version: -40 to +105°C

1. Overview

1.1 Outline of Specifications

Table 1.1 lists the specifications in outline, and Table 1.2 lists the functions of products.

Table 1.1 shows the outline of maximum specifications, and the number of peripheral module channels differs depending on the pin number on the package and the ROM capacity. For details, see Table 1.2, Comparison of Functions for Different Packages.

Table 1.1 Outline of Specifications (1/5)

Classification	Module/Function	Description
CPU	CPU	<ul style="list-style-type: none"> Maximum operating frequency: 100 MHz 32-bit RX CPU Minimum instruction execution time: One instruction per state (cycle of the system clock) Address space: 4-Gbyte linear Register set of the CPU General purpose: Sixteen 32-bit registers Control: Nine 32-bit registers Accumulator: One 64-bit register Basic instructions: 73 Floating-point operation instructions: 8 DSP instructions: 9 Addressing modes: 10 Data arrangement Instructions: Little endian Data: Selectable as little endian or big endian On-chip 32-bit multiplier: 32 × 32 → 64 bits On-chip divider: 32 / 32 → 32 bits Barrel shifter: 32 bits Memory protection unit (MPU)
	FPU	<ul style="list-style-type: none"> Single precision floating point (32 bits) Data types and floating-point exceptions in conformance with the IEEE754 standard
Memory	ROM	<ul style="list-style-type: none"> Capacity: 384 Kbytes, 512 Kbytes, 768 Kbytes, 1 Mbyte, 1.5 Mbytes, 2 Mbytes 100 MHz, no-wait access On-board programming: Four types Off-board programming (parallel programmer mode)
	RAM	<ul style="list-style-type: none"> Capacity: 64 Kbytes, 96 Kbytes, 128 Kbytes 100 MHz, no-wait access
	E ² data flash	<ul style="list-style-type: none"> Capacity: 32 Kbytes Programming/erasing: 100,000 times
MCU operating modes		Single-chip mode, on-chip ROM enabled extended mode, and on-chip ROM disabled extended mode (software switching)
Clock	Clock generation circuit	<ul style="list-style-type: none"> Main clock oscillator, sub-clock oscillator, low-speed/high-speed on-chip oscillator, PLL frequency synthesizer, and dedicated on-chip oscillator for the IWDG Main-clock oscillation stop detection Separate frequency-division and multiplication settings for the system clock (ICLK), peripheral module clock (PCLK), FlashIF clock (FCLK) and external bus clock (BCLK) The CPU and other bus masters run in synchronization with the system clock (ICLK): Up to 100 MHz Peripheral modules run in synchronization with the peripheral module clock (PCLK): Up to 50 MHz Flash IF run in synchronization with the FlashIF clock (FCLK): Up to 50 MHz Devices connected to the external bus run in synchronization with the external bus clock (BCLK): Up to 50 MHz
Reset		RES# pin reset, power-on reset, voltage-monitoring reset, independent watchdog timer reset, watchdog timer reset, deep software standby reset, and software reset
Voltage detection circuit		When the voltage on VCC passes the voltage detection level (Vdet), an internal reset or internal interrupt is generated.

Table 1.1 Outline of Specifications (2/5)

Classification	Module/Function	Description
Low power consumption	Low power consumption facilities	<ul style="list-style-type: none"> • Module stop function • Four low power consumption modes Sleep mode, all-module clock stop mode, software standby mode, and deep software standby mode • Battery backup function
Interrupt	Interrupt controller (ICUb)	<ul style="list-style-type: none"> • Peripheral function interrupts: 180 sources • External interrupts: 16 (pins IRQ0 to IRQ15) • Software interrupts: One source • Non-maskable interrupts: 6 sources • Sixteen levels specifiable for the order of priority
External bus extension		<ul style="list-style-type: none"> • The external address space can be divided into eight areas (CS0 to CS7), each with independent control of access settings. Capacity of each area: 16 Mbytes (CS0 to CS7) A chip-select signal (CS0# to CS7#) can be output for each area. Each area is specifiable as an 8-, 16- or 32-bit bus space The data arrangement in each area is selectable as little or big endian (only for data). • Bus format: Separate bus, multiplex bus • Wait control • Write buffer facility
DMA	DMA controller (DMACA)	<ul style="list-style-type: none"> • 4 channels • Three transfer modes: Normal transfer, repeat transfer, and block transfer • Activation sources: Software trigger, external interrupts, and interrupt requests from peripheral functions
	Data transfer controller (DTCa)	<ul style="list-style-type: none"> • Three transfer modes: Normal transfer, repeat transfer, and block transfer • Activation sources: External interrupts and interrupt requests from peripheral functions
I/O ports	General I/O port pins	<ul style="list-style-type: none"> • 177-pin TFLGA (in planning), 176-pin LFBGA (in planning), 176-pin LQFP I/O pins: 148 Input pin: 1 Pull-up resistors: 148 Open-drain outputs: 148 5-V tolerance: 54 • 145-pin TFLGA (in planning), 144-pin LQFP I/O pins: 117 Input pin: 1 Pull-up resistors: 117 Open-drain outputs: 117 5-V tolerance: 53 • 100-pin TFLGA (in planning), 100-pin LQFP I/O pins: 78 Input pin: 1 Pull-up resistors: 78 Open-drain outputs: 78 5-V tolerance: 44 • 80-pin LQFP (in planning) I/O pins: 58 Input pin: 1 Pull-up resistors: 58 Open-drain outputs: 58 5-V tolerance: 34

Table 1.1 Outline of Specifications (3/5)

Classification	Module/Function	Description
Timers	16-bit timer pulse unit (TPUa)	<ul style="list-style-type: none"> • (16 bits × 6 channels) × 2 units • Maximum of 16 pulse-input/output possible • Select from among seven or eight counter-input clock signals for each channel • Supports the input capture/output compare function • Output of PWM waveforms in up to 15 phases in PWM mode • Support for buffered operation, phase-counting mode (two phase encoder input) and cascade-connected operation (32 bits × 2 channels) depending on the channel. • PPG output trigger can be generated • Capable of generating conversion start triggers for the A/D converters • Signals from the input capture pins are input via a digital filter • Clock frequency measuring method
	Multi-function timer pulse unit 2 (MTU2a)	<ul style="list-style-type: none"> • (16 bits × 6 channels) × 1 unit • Time bases for the 6 16-bit timer channels can be provided via up to 16 pulse-input/output lines and three pulse-input lines • Select from among eight counter-input clock signals for each channel (PCLK/1, PCLK/4, PCLK/16, PCLK/64, MTCLKA, MTCLKB, MTCLKC, MTCLKD) other than channel 5, for which only four signals are available. • Input capture function • 21 output compare/input capture registers • Complementary PWM output mode • Reset synchronous PWM mode • Phase-counting mode • Generation of triggers for A/D converter conversion • Digital filter • Signals from the input capture pins are input via a digital filter • PPG output trigger can be generated • Clock frequency measuring function
	Frequency measurement function (MCK)	The MTU or unit 0 TPU module can be used to monitor the main clock, sub-clock, HOCO clock, LOCO clock, and PLL clock for abnormal frequencies.
	Port output enable 2 (POE2a)	Controls the high-impedance state of the MTU's waveform output pins
	Programmable pulse generator (PPG)	<ul style="list-style-type: none"> • (4 bits × 4 groups) × 2 units • Pulse output with the MTU or TPU output as a trigger • Maximum of 32 pulse-output possible
	8-bit timers (TMR)	<ul style="list-style-type: none"> • (8 bits × 2 channels) × 2 units • Select from among seven internal clock signals (PCLK/1, PCLK/2, PCLK/8, PCLK/32, PCLK/64, PCLK/1024, PCLK/8192) and one external clock signal • Capable of output of pulse trains with desired duty cycles or of PWM signals • The 2 channels of each unit can be cascaded to create a 16-bit timer • Generation of triggers for A/D converter conversion • Capable of generating baud-rate clocks for SCI5, SCI6, and SCI12
	Compare match timer (CMT)	<ul style="list-style-type: none"> • (16 bits × 2 channels) × 2 units • Select from among four internal clock signals (PCLK/8, PCLK/32, PCLK/128, PCLK/512)
	Realtime clock (RTCa)	<ul style="list-style-type: none"> • Clock sources: Main clock, sub-clock • Clock and calendar functions • Interrupt sources: Alarm interrupt, periodic interrupt, and carry interrupt • Battery backup operation • Time-capture facility for three values
	Watchdog timer (WDTA)	<ul style="list-style-type: none"> • 14 bits × 1 channel • Select from among 6 counter-input clock signals (PCLK/4, PCLK/64, PCLK/128, PCLK/512, PCLK/2048, PCLK/8192)
	Independent watchdog timer (IWDTA)	<ul style="list-style-type: none"> • 14 bits × 1 channel • Counter-input clock: Dedicated on-chip oscillator for the IWDT • Dedicated clock/1, dedicated clock/16, dedicated clock/32, dedicated clock/64, dedicated clock/128, dedicated clock/256

Table 1.1 Outline of Specifications (4/5)

Classification	Module/Function	Description
Communication function	USB 2.0 function module (USBa)	<ul style="list-style-type: none"> Includes a UDC (USB Device Controller) and transceiver for USB 2.0 Single port Compliance with the USB 2.0 specification Transfer rate: Full speed (12 Mbps) Self-power mode and bus power are selectable Incorporates 2 Kbytes of RAM as a transfer buffer
	Serial communications interfaces (SC1c, SC1d)	<ul style="list-style-type: none"> 13 channels (SC1c: 12 channels + SC1d: 1 channel) SC1c <ul style="list-style-type: none"> Serial communications modes: Asynchronous, clock synchronous, and smart-card interface Multi-processor function On-chip baud rate generator allows selection of the desired bit rate Choice of LSB-first or MSB-first transfer Average transfer rate clock can be input from TMR timers for SC15, SC16, and SC12 Simple I²C Simple SPI SC1d (The following functions are added to SC1c) <ul style="list-style-type: none"> Supports the serial communications protocol, which contains the start frame and information frame Supports the LIN format
	I ² C bus interfaces (RIIC)	<ul style="list-style-type: none"> 4 channels (one of them is FM+) Communication formats I²C bus format/SMBus format Supports the multi-master Max. transfer rate: 1 Mbps (channel 0)
	IEBus (IEB)	<ul style="list-style-type: none"> 1 channel Supports protocol control for the IEBus Half-duplex asynchronous transfer Multi-master operation Broadcast communications function Two selectable modes, differentiated by transfer rate
	CAN module (CAN)	<ul style="list-style-type: none"> 3 channels Compliance with the ISO11898-1 specification (standard frame and extended frame) 32 mailboxes per channel
	Serial peripheral interfaces (RSPI)	<ul style="list-style-type: none"> 3 channels RSPI transfer facility <ul style="list-style-type: none"> Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPCK (RSPI clock) signals enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) Capable of handling serial transfer as a master or slave Data formats <ul style="list-style-type: none"> Switching between MSB first and LSB first The number of bits in each transfer can be changed to any number of bits from 8 to 16, or to 20, 24, or 32 bits. 128-bit buffers for transmission and reception Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) Buffered structure <ul style="list-style-type: none"> Double buffers for both transmission and reception
	12-bit A/D converter (S12ADa)	<ul style="list-style-type: none"> 1 unit (1 unit × 21 channels) 12-bit resolution Conversion time: 1.0 μs per channel (in operation with PCLK at 50 MHz) Operating mode <ul style="list-style-type: none"> Scan mode (single scan mode or continuous scan mode) Sample-and-hold function Reference voltage generation Three ways to start A/D conversion <ul style="list-style-type: none"> Conversion can be started by a software trigger, a trigger from a timer (MTU, TPU, or TMR), or an external trigger signal A/D conversion of the temperature sensor output

Table 1.1 Outline of Specifications (5/5)

Classification	Module/Function	Description
10-bit A/D converter (ADb)		<ul style="list-style-type: none"> • 1 unit (1 unit × 8 channels) • 10-bit resolution • Conversion time: 1.0 μs per channel (in operation with PCLK at 50 MHz) • Operating mode Scan mode (single scan mode or continuous scan mode) External amplifier connection mode • Sample-and-hold function • Three ways to start A/D conversion Conversion can be started by software, a conversion start trigger from a timer (MTU, TPU, or TMR), or an external trigger signal.
D/A converter (DAa)		<ul style="list-style-type: none"> • 2 channels • 10-bit resolution • Output voltage: 0 V to VREFH
Temperature sensor		<ul style="list-style-type: none"> • 1 channel • Precision: ± 1 °C • The voltage of the temperature is converted into a digital value by the 12-bit A/D converter.
CRC calculator (CRC)		<ul style="list-style-type: none"> • CRC code generation for arbitrary amounts of data in 8-bit units • Select any of three generating polynomials: $X^8 + X^2 + X + 1$, $X^{16} + X^{15} + X^2 + 1$, or $X^{16} + X^{12} + X^5 + 1$. • Generation of CRC codes for use with LSB-first or MSB-first communications is selectable
Unique ID		A 16-byte device-specific ID (only for the G version)
Operating frequency		Up to 100 MHz
Power supply voltage		VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0, Vbatt = 2.3 to 3.6 V
Operating temperature		D version: -40 to +85°C, G version: -40 to +105°C*1
Package		177-pin TFLGA (PTLG0177KA-A) (in planning) 176-pin LFBGA (PLBG0176GA-A) (in planning) 176-pin LQFP (PLQP0176KB-A) 145-pin TFLGA (PTLG0145KA-A) (in planning) 144-pin LQFP (PLQP0144KA-A) 100-pin TFLGA (PTLG0100KA-A) (in planning) 100-pin LQFP (PLQP0100KB-A) 80-pin LQFP (PLQP0080KB-A) (in planning)
On-chip debugging system		<ul style="list-style-type: none"> • E1 emulator (JTAG and FINE interfaces) • E20 emulator (JTAG interface)

Note 1. Please contact us if you are using a G version.

Table 1.2 Comparison of Functions for Different Packages

Functions		RX630 Group			
		177 Pins, 176 Pins	145 Pins, 144 Pins	100 Pins	80 Pins
External bus	External bus width	32 bits	16 bits		Not supported
DMA	DMA controller	Ch. 0 to 3			
	Data transfer controller	Supported			
Timers	16-bit timer pulse unit	Ch. 0 to 11		Ch. 0 to 5	
	Multi-function timer pulse unit 2	Ch. 0 to 5			
	Port output enable 2	Supported			
	Programmable pulse generator	Ch. 0 and 1			
	8-bit timers	Ch. 0 to 3			
	Compare match timer	Ch. 0 to 3			
	Realtime clock	Supported			
	Watchdog timer	Supported			
	Independent watchdog timer	Supported			
Communication function	USB 2.0 function module	Ch. 0			
	Serial communications interfaces (SC1c)	Ch. 0 to 11		Ch. 0 to 3, 5, 6, 8, 9	Ch. 1, 5, 6, 8, 9
	Serial communications interfaces (SC1d)	Ch. 12			
	I ² C bus interfaces	Ch. 0 to 3		Ch. 0, 2	
	IEBus	Supported			
	Serial peripheral interfaces	Ch. 0 to 2		Ch. 0, 1	
	CAN module	For 1 M or less: Ch. 0, 1 For 1.5 M or more: Ch. 0 to 2		For 512 K or less: Ch. 1 For 768 K or more: Ch. 0, 1	Ch. 1
12-bit A/D converter		AN000 to 020		AN000 to 013	AN000 to 010
10-bit A/D converter		AN0 to 7			AN0 to 3
D/A converter		Ch. 0, 1		Ch. 1	
Temperature sensor		Supported			
CRC calculator		Supported			
Unique ID		Available (only for the G version)			

1.2 List of Products

Table 1.3 is a list of products, and Figure 1.1 shows how to read the product part number.

Table 1.3 List of Products (1/2)

Group	Part No.	Package	ROM Capacity	RAM Capacity	E2 Data Flash	Operating Frequency (Max.)	Operating Temp. Range
RX630 (D version)	R5F56307CDFN	PLQP0080KB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56307DDFN	PLQP0080KB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56307CDFP	PLQP0100KB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56307DDFP	PLQP0100KB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56307CDLA	PTLG0100KA-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56307DDLA	PTLG0100KA-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56308CDFN	PLQP0080KB-A	512 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56308DDFN	PLQP0080KB-A	512 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56308CDFP	PLQP0100KB-A	512 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56308DDFP	PLQP0100KB-A	512 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56308CDLA	PTLG0100KA-A	512 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56308DDLA	PTLG0100KA-A	512 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ACDFP*1	PLQP0100KB-A	768 Kbytes	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ADDFP*1	PLQP0100KB-A	768 Kbytes	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ACDFB*1	PLQP0144KA-A	768 Kbytes	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ADDFB*1	PLQP0144KA-A	768 Kbytes	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ACDLK*1	PTLG0145KA-A	768 Kbytes	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ADDLK*1	PTLG0145KA-A	768 Kbytes	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ACDFC	PLQP0176KB-A	768 Kbytes	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ADDFC	PLQP0176KB-A	768 Kbytes	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ACDBG	PLBG0176GA-A	768 Kbytes	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ADDBG	PLBG0176GA-A	768 Kbytes	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ACDLC	PTLG0177KA-A	768 Kbytes	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ADDLC	PTLG0177KA-A	768 Kbytes	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630BCDFP*1	PLQP0100KB-A	1 Mbyte	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630BDDFP*1	PLQP0100KB-A	1 Mbyte	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630BCDFB*1	PLQP0144KA-A	1 Mbyte	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630BDDFB*1	PLQP0144KA-A	1 Mbyte	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630BCDLK*1	PTLG0145KA-A	1 Mbyte	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630BDDLK*1	PTLG0145KA-A	1 Mbyte	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630BCDFC	PLQP0176KB-A	1 Mbyte	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630BDDFC	PLQP0176KB-A	1 Mbyte	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630BCDBG	PLBG0176GA-A	1 Mbyte	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630BDDBG	PLBG0176GA-A	1 Mbyte	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630BCDLC	PTLG0177KA-A	1 Mbyte	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630BDDLK	PTLG0177KA-A	1 Mbyte	96 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630DCDFP	PLQP0100KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630DDDFP	PLQP0100KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630DCDFB	PLQP0144KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630DDDFB	PLQP0144KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
R5F5630DCDLK	PTLG0145KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C	

Table 1.3 List of Products (2/2)

Group	Part No.	Package	ROM Capacity	RAM Capacity	E2 Data Flash	Operating Frequency (Max.)	Operating Temp. Range
RX630 (D version)	R5F5630DDDLK	PTLG0145KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630DCDFC	PLQP0176KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630DDDFC	PLQP0176KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630DCDBG	PLBG0176GA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630DDDBG	PLBG0176GA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630DCDLC	PTLG0177KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630DDDLK	PTLG0177KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ECDFP	PLQP0100KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630EDDFP	PLQP0100KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ECDFB	PLQP0144KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630EDDFB	PLQP0144KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ECDLK	PTLG0145KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630EDDLK	PTLG0145KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ECDFC	PLQP0176KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630EDDFC	PLQP0176KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ECDBG	PLBG0176GA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630EDDBG	PLBG0176GA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630ECDLC	PTLG0177KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5630EDDLK	PTLG0177KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	RX630 (G version) *2	R5F5630BDGFB	PLQP0144KA-A	1 Mbyte	96 Kbytes	32 Kbytes	100MHz
R5F5630ADGFB		PLQP0144KA-A	768 Kbytes	96 Kbytes	32 Kbytes	100MHz	-40 to +105°C
R5F5630BDGFP		PLQP0100KB-A	1 Mbyte	96 Kbytes	32 Kbytes	100MHz	-40 to +105°C
R5F5630ADGFP		PLQP0100KB-A	768 Kbytes	96 Kbytes	32 Kbytes	100MHz	-40 to +105°C
R5F56308DGFP		PLQP0100KB-A	512 Kbytes	64 Kbytes	32 Kbytes	100MHz	-40 to +105°C
R5F56307DGFP		PLQP0100KB-A	384 Kbytes	64 Kbytes	32 Kbytes	100MHz	-40 to +105°C
R5F56308DGFN		PLQP0080KB-A	512 Kbytes	64 Kbytes	32 Kbytes	100MHz	-40 to +105°C
R5F56307DGFN		PLQP0080KB-A	384 Kbytes	64 Kbytes	32 Kbytes	100MHz	-40 to +105°C

Note 1. The sub-clock oscillator, real-time clock, and boundary scan have different specifications. For details, see section 11.2.8, Sub-Clock Oscillator Wait Control Register (SOSCWTCR), section 28.2.19, RTC Control Register 3 (RCR3), and section 44.2.4, Boundary Scan Register (JTBSR) in the User's manual: Hardware.

Note 2. The specifications of the temperature sensor calibration and unique ID for G-version products differ from those for other products. For details, see section 41.2.2, Temperature Sensor Calibration Data Registers (TSCDRH, TSCDRL), section 41.3, Using the Temperature Sensor, and section 43.2.22, Unique ID Registers n (UIDRn) (n = 0 to 15) in the User's manual: Hardware.

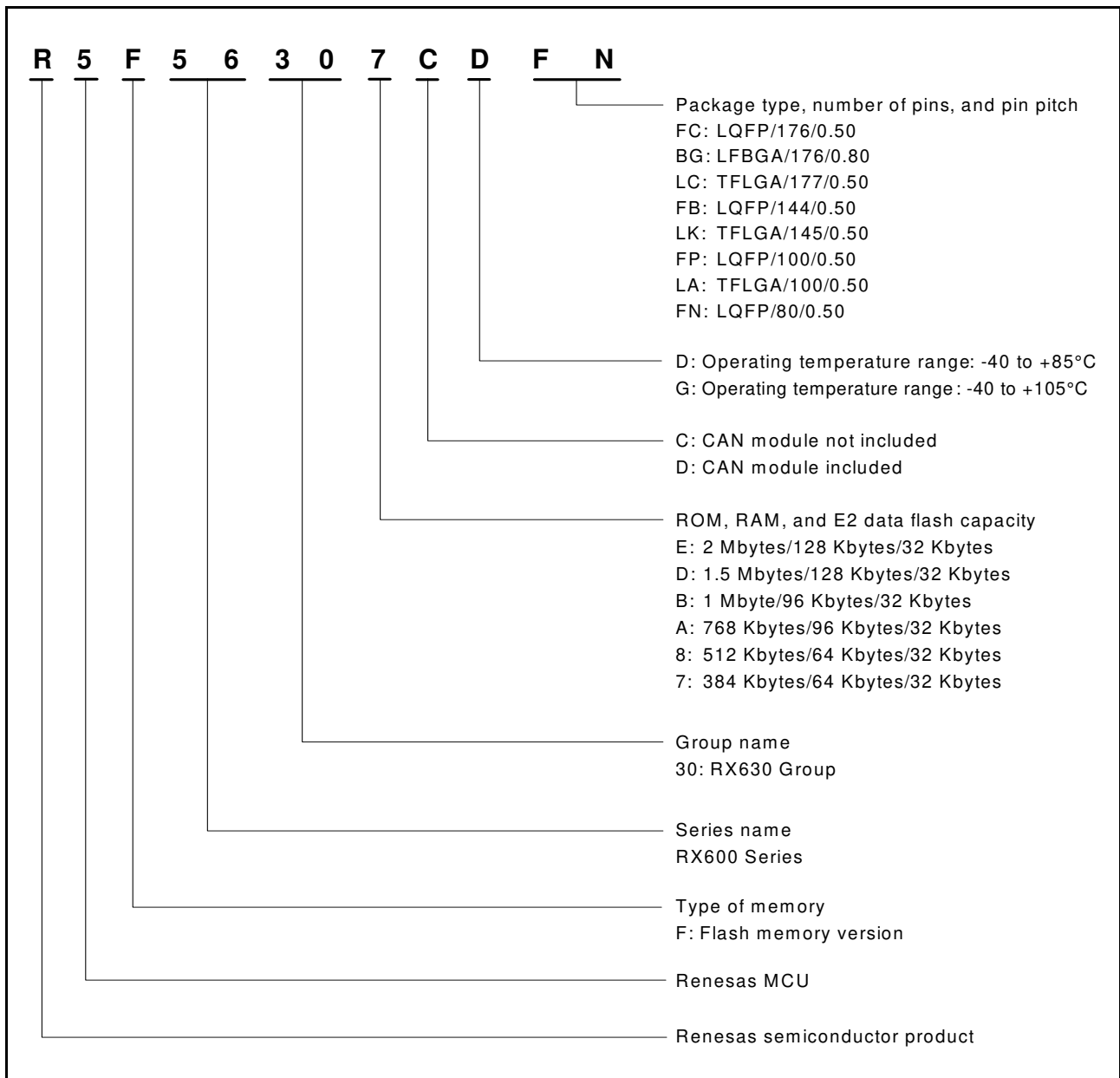


Figure 1.1 How to Read the Product Part Number

1.3 Block Diagram

Figure 1.2 shows a block diagram.

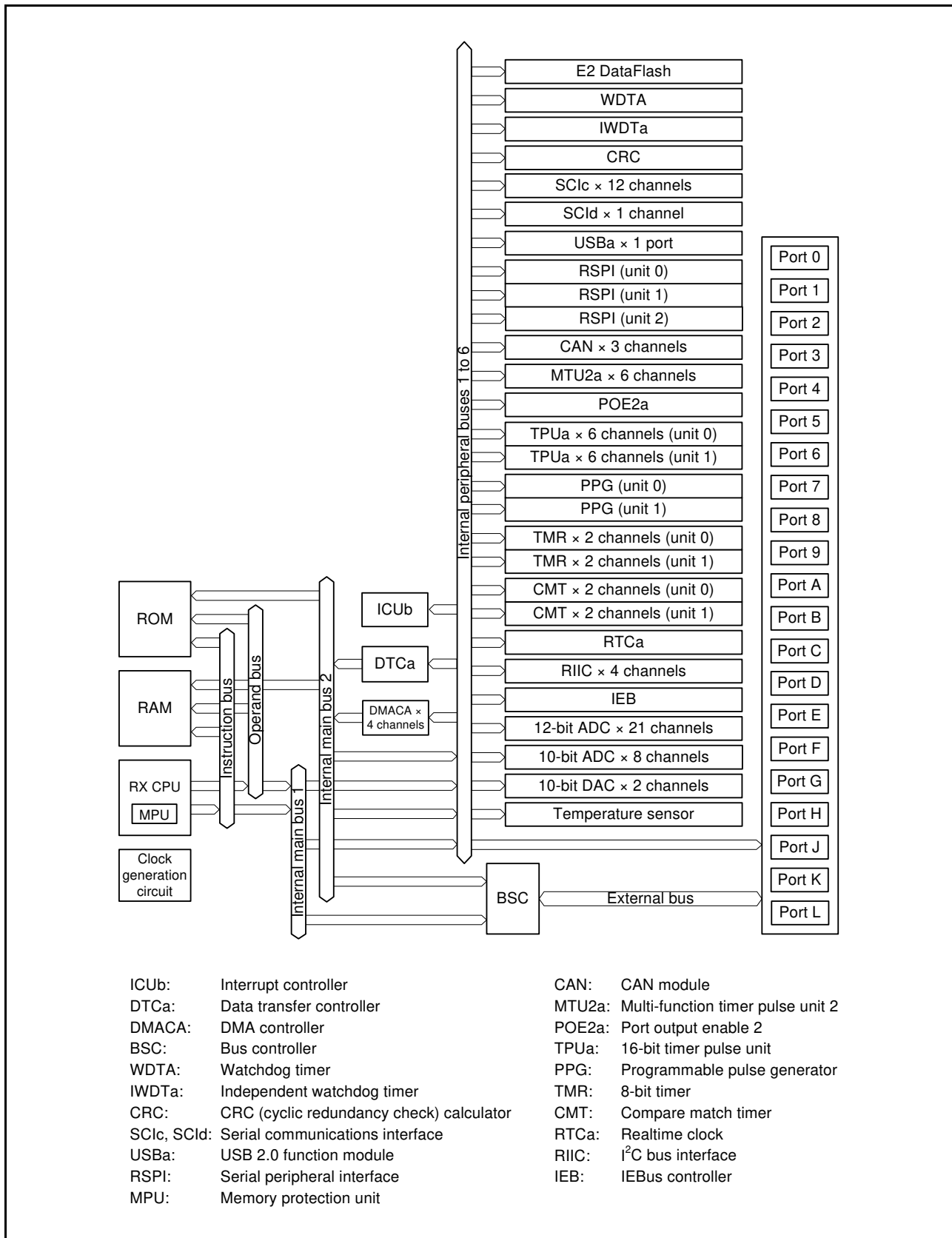


Figure 1.2 Block Diagram

1.4 Pin Functions

Table 1.4 lists the pin functions.

Table 1.4 Pin Functions (1/5)

Classifications	Pin Name	I/O	Description
Power supply	VCC	Input	Power supply pin. Connect it to the system power supply. Connect this pin to VSS via a 0.1- μ F capacitor. The capacitor should be placed close to the pin
	VCL	Input	Connect this pin to VSS via a 0.1- μ F capacitor. The capacitor should be placed close to the pin
	VSS	Input	Ground pin. Connect it to the system power supply (0 V)
	VBATT	Input	Backup power pin. When the battery backup function is not to be used, connect it to the VCC pin.
Clock	XTAL	Output	Pins for a crystal resonator. An external clock signal can be input through the EXTAL pin
	EXTAL	Input	
	BCLK	Output	Outputs the external bus clock for external devices
	XCOU	Output	Input/output pins for the sub-clock oscillator circuit. Connect a crystal resonator between XCOU and XCIN
	XCIN	Input	
Operating mode control	MD	Input	Pin for setting the operating mode. The signal levels on these pins must not be changed during operation
System control	RES#	Input	Reset signal input pin. This LSI enters the reset state when this signal goes low
	EMLE	Input	Input pin for the on-chip emulator enable signal. When the on-chip emulator is used, this pin should be driven high. When not used, it should be driven low
	BSCANP	Input	Boundary scan enable pin. Boundary scan is enabled when this pin goes high. When not used, it should be driven low
On-chip emulator	FINEC	Input	Fine interface clock pin
	FINED	I/O	Fine interface pin
	TRST#	Input	On-chip emulator or boundary scan pins. When the EMLE pin is driven high, these pins are dedicated for the on-chip emulator
	TMS	Input	
	TDI	Input	
	TCK	Input	
	TDO	Output	
	TRCLK	Output	This pin outputs the clock for synchronization with the trace data
	TRSYNC	Output	This pin indicates that output from the TRDATA0 to TRDATA3 pins is valid
TRDATA0 to TRDATA3	Output	These pins output the trace information	
Address bus	A0 to A23	Output	Output pins for the address
Data bus	D0 to D31	I/O	Input and output pins for the bidirectional data bus
Multiplexed bus	A0/D0 to A15/D15	I/O	Address/data multiplexed bus

Table 1.4 Pin Functions (2/5)

Classifications	Pin Name	I/O	Description
Bus control	RD#	Output	Strobe signal which indicates that reading from the external bus interface space is in progress
	WR#	Output	Strobe signal which indicates that writing to the external bus interface space is in progress, in 1-write strobe mode
	WR0# to WR3#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0, D15 to D8, D23 to D16 and D31 to D24) is valid in writing to the external bus interface space, in byte strobe mode
	BC0# to BC3#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0, D15 to D8, D23 to D16 and D31 to D24) is valid in access to the external bus interface space, in 1-write strobe mode
	ALE	Output	Address latch signal when address/data multiplexed bus is selected
	WAIT#	Input	Input pin for wait request signals in access to the external space
	CS0# to CS7#	Output	Select signals for CS areas
Interrupt	NMI	Input	Non-maskable interrupt request pin
	IRQ0 to IRQ15	Input	Maskable interrupt request pin
Multi-function timer pulse unit 2	MTIOC0A, MTIOC0B MTIOC0C, MTIOC0D	I/O	The TGRA0 to TGRD0 input capture input/output compare output/PWM output pins
	MTIOC1A, MTIOC1B	I/O	The TGRA1 and TGRB1 input capture input/output compare output/PWM output pins
	MTIOC2A, MTIOC2B	I/O	The TGRA2 and TGRB2 input capture input/output compare output/PWM output pins
	MTIOC3A, MTIOC3B MTIOC3C, MTIOC3D	I/O	The TGRA3 to TGRD3 input capture input/output compare output/PWM output pins
	MTIOC4A, MTIOC4B MTIOC4C, MTIOC4D	I/O	The TGRA4 to TGRD4 input capture input/output compare output/PWM output pins
	MTIC5U, MTIC5V MTIC5W	Input	The TGRU5, TGRV5, and TGRW5 input capture input/dead time compensation input pins
	MTCLKA, MTCLKB MTCLKC, MTCLKD	Input	Input pins for external clock
Port output enable 2	POE0# to POE3# POE8#	Input	Input pins for request signals to place the MTU large-current pins in the high impedance state

Table 1.4 Pin Functions (3/5)

Classifications	Pin Name	I/O	Description
16-bit timer pulse unit	TIOCA0, TIOCB0 TIOCC0, TIOCD0	I/O	The TGRA0 to TGRD0 input capture input/output compare output/ PWM output pins
	TIOCA1, TIOCB1	I/O	The TGRA1 and TGRB1 input capture input/output compare output/ PWM output pins
	TIOCA2, TIOCB2	I/O	The TGRA2 and TGRB2 input capture input/output compare output/ PWM output pins
	TIOCA3, TIOCB3 TIOCC3, TIOCD3	I/O	The TGRA3 to TGRD3 input capture input/output compare output/ PWM output pins
	TIOCA4, TIOCB4	I/O	The TGRA4 and TGRB4 input capture input/output compare output/ PWM output pins
	TIOCA5, TIOCB5	I/O	The TGRA5 and TGRB5 input capture input/output compare output/ PWM output pins
	TCLKA, TCLKB TCLKC, TCLKD	Input	Input pins for external clock signals
	TIOCA6, TIOCB6, TIOCC6, TIOCD6	I/O	The TGRA6 to TGRD6 input capture input/output compare output/ PWM output pins
	TIOCA7, TIOCB7	I/O	The TGRA7 and TGRB7 input capture input/output compare output/ PWM output pins
	TIOCA8, TIOCB8	I/O	The TGRA8 and TGRB8 input capture input/output compare output/ PWM output pins
	TIOCA9, TIOCB9, TIOCC9, TIOCD9	I/O	The TGRA9 to TGRD9 input capture input/output compare output/ PWM output pins
	TIOCA10, TIOCB10	I/O	The TGRA10 and TGRB10 input capture input/output compare output/PWM output pins
	TIOCA11, TIOCB11	I/O	The TGRA11 and TGRB11 input capture input/output compare output/PWM output pins
TCLKE, TCLKF, TCLKG, TCLKH	Input	Input pins for external clock signals	
Programmable pulse generator	PO0 to PO31	Output	Output pins for the pulse signals
8-bit timer	TMO0 to TMO3	Output	Compare match output pins
	TMCI0 to TMCI3	Input	Input pins for external clocks to be input to the counter
	TMRI0 to TMRI3	Input	Input pins for the counter reset
Serial communications interface (SCIc)	• Asynchronous mode/clock synchronous mode		
	SCK0 to SCK11	I/O	Input/output pins for the clock
	RXD0 to RXD11	Input	Input pins for received data
	TXD0 to TXD11	Output	Output pins for transmitted data
	CTS0# to CTS11#	Input	Input pins for controlling the start of transmission and reception
	RTS0# to RTS11#	Output	Output pins for controlling the start of transmission and reception
	• Simple I ² C mode		
	SSCL0 to SSCL11	I/O	Input/output pins for the I ² C clock
	SSDA0 to SSDA11	I/O	Input/output pins for the I ² C data
	• Simple SPI mode		
	SCK0 to SCK11	I/O	Input/output pins for the clock
	SMISO0 to SMISO11	I/O	Input/output pins for slave transmission of data
	SMOSI0 to SMOSI11	I/O	Input/output pins for master transmission of data
	SS0# to SS11#	Input	Chip-select input pins

Table 1.4 Pin Functions (4/5)

Classifications	Pin Name	I/O	Description	
Serial communications interface (SCId)	• Asynchronous mode/clock synchronous mode			
	SCK12	I/O	Input/output pin for the clock	
	RXD12	Input	Input pin for received data	
	TXD12	Output	Output pin for transmitted data	
	CTS12#	Input	Input pin for controlling the start of transmission and reception	
	RTS12#	Output	Output pin for controlling the start of transmission and reception	
	• Simple I ² C mode			
	SSCL12	I/O	Input/output pin for the I ² C clock	
	SSDA12	I/O	Input/output pin for the I ² C data	
	• Simple SPI mode			
	SCK12	I/O	Input/output pin for the clock	
	SMISO12	I/O	Input/output pin for slave transmission of data	
	SMOSI12	I/O	Input/output pin for master transmission of data	
	SS12#	Input	Chip-select input pin	
	• Extended serial mode			
	RDX12	Input	Input pin for received data	
	TXDX12	Output	Output pin for transmitted data	
	SIOX12	I/O	Input/output pin for received or transmitted data	
	I ² C bus interface	SCL0[FM+], SCL1 to SCL3	I/O	Input/output pins for clocks. Bus can be directly driven by the N-channel open drain
		SDA0[FM+], SDA1 to SDA3	I/O	Input/output pins for data. Bus can be directly driven by the N-channel open drain
USB power pins	VCC_USB	Input	Power supply pin. When the USB is not to be used, connect it to the VCC pin.	
	VSS_USB	Input	Ground pin. When the USB is not to be used, connect it to the VSS pin.	
USB 2.0 function module	USB0_DP	I/O	Inputs or outputs D+ data for the USB bus	
	USB0_DM	I/O	Inputs or outputs D- data for the USB bus	
	USB0_DPUPE	Output	Pull-up pin	
	USB0_VBUS	Input	Input pin for detection of connection and disconnection of the USB cable	
CAN module	CRX0 to CRX2	Input	Input pins	
	CTX0 to CTX2	Output	Output pins	
Serial peripheral interface	RSPCKA, RSPCKB, RSPCKC	I/O	Clock input/output pins	
	MOSIA, MOSIB, MOSIC	I/O	Inputs or outputs data output from the master	
	MISOA, MISOB, MISOC	I/O	Inputs or outputs data output from the slave	
	SSLA0, SSLB0, SSLC0	I/O	Input or output pins for slave selection	
	SSLA1 to SSLA3, SSLB1 to SSLB3, SSLC1 to SSLC3	Output	Output pins for slave selection	
IEBus controller	IERXD	Input	Input pin for data reception	
	IETXD	Output	Output pin for data transmission	
Realtime clock	RTCOUT	Output	Output pin for 1-Hz clock	
	RTCIC0 to RTCIC2	Input	Time capture event input pin	

Table 1.4 Pin Functions (5/5)

Classifications	Pin Name	I/O	Description
12-bit A/D converter	AN000 to AN020	Input	Input pins for the analog signals to be processed by the A/D converter
	ADTRG0#	Input	Input pins for the external trigger signals that start the A/D conversion
10-bit A/D converter	AN0 to AN7	Input	Input pins for the analog signals to be processed by the A/D converter
	ANEX0	Output	Extended analog output pin
	ANEX1	Input	Extended analog input pin
	ADTRG#	Input	Input pins for the external trigger signals that start the A/D conversion
D/A converter	DA0, DA1	Output	Output pins for the analog signals to be processed by the D/A converter
Analog power supply	AVCC0	Input	Analog voltage supply pin for the 12-bit A/D converter. Connect this pin to VCC if the 12-bit A/D converter is not to be used
	AVSS0	Input	Analog ground pin for the 12-bit A/D converter. Connect this pin to VSS if the 12-bit A/D converter is not to be used
	VREFH0	Input	Analog reference voltage supply pin for the 12-bit A/D converter. Connect this pin to VCC if the 12-bit A/D converter is not to be used
	VREFL0	Input	Analog reference ground pin for the 12-bit A/D converter. Connect this pin to VSS if the 12-bit A/D converter is not to be used
	VREFH	Input	Reference voltage input pin for the 10-bit A/D converter and D/A converter. This is used as the analog power supply for the respective modules. Connect this pin to VCC if neither the 10-bit A/D converter nor the D/A converter is in use
	VREFL	Input	Reference ground pin for the 10-bit A/D converter and D/A converter. This is used as the analog ground for the respective modules. Set this pin to the same potential as the VSS pin
I/O ports	P00 to P03, P05, P07	I/O	6-bit input/output pins
	P10 to P17	I/O	8-bit input/output pins
	P20 to P27	I/O	8-bit input/output pins
	P30 to P37	I/O	8-bit input/output pins (P35: input pin)
	P40 to P47	I/O	8-bit input/output pins
	P50 to P57	I/O	8-bit input/output pins
	P60 to P67	I/O	8-bit input/output pins
	P70 to P77	I/O	8-bit input/output pins
	P80 to P87	I/O	8-bit input/output pins
	P90 to P97	I/O	8-bit input/output pins
	PA0 to PA7	I/O	8-bit input/output pins
	PB0 to PB7	I/O	8-bit input/output pins
	PC0 to PC7	I/O	8-bit input/output pins
	PD0 to PD7	I/O	8-bit input/output pins
	PE0 to PE7	I/O	8-bit input/output pins
	PF0 to PF5	I/O	6-bit input/output pins
	PG0 to PG7	I/O	8-bit input/output pins
	PH4, PH5	I/O	2-bit input/output pins
	PJ3, PJ5	I/O	2-bit input/output pins
	PK0 to PK7	I/O	8-bit input/output pins
PL0 to PL4	I/O	5-bit input/output pins	

1.5 Pin Assignments

Figure 1.3 to Figure 1.10 show the pin assignments. Table 1.5 to Table 1.11 show the lists of pins and pin functions.

	A	B	C	D	E	F	G	H	J	K	L	M	N	P	R			
15	PE2	PE3	P70	P65	P67	VSS	VCC	PG7	PA6	PB0	P72	PB4	PL0	PL1	PC1	15		
14	PE1	PE0	PK4	PE7	PG3	PA0	PA1	PA2	PA7	PK7	PB1	PB5	P73	P75	P74	14		
13	P63	P64	PE4	PK5	PG2	PG4	PG6	PA3	PK6	P71	PB3	PB7	PC0	PC2	P76	13		
12	P60	PK3	P62	PE5	PE6	P66	PG5	PA4	PA5	PB2	PB6	P77	PC3	PC4	P80	12		
11	PD6	PG1	PK2	P61	RX630 Group PTLG0177KA-A (177-Pin TFLGA) (Upper perspective view)								P81	P82	PC6	VCC	11	
10	P97	PD4	PG0	PD7									PC5	PC7	P83	VSS	10	
9	PK0	P96	PD3	PD5									P50	P51	P52	P84	9	
8	P94	PD1	PD2	PK1									P53	PL2	PL3	PL4	8	
7	VSS	P92	PD0	P95									P54	P55	VSS_USB	USB0_DP	7	
6	VCC	P91	P90	P93									P56	P57	VCC_USB	USB0_DM	6	
5	P46	P47	P45	P44									NC	P13	P12	P10	P11	5
4	P42	P41	P43	P00									VSS	BSCANP	PF4	P35	PF3	PF1
3	VREFL0	P40	VREFH0	P03	PF5	PJ3	MD	RES#	P34	PF2	PF0	P24	P22	P87	P16	3		
2	AVCC0	P07	VREFH	P02	EMLE	VCL	XCOUT	VSS	VCC	P32	P30	P26	P23	P17	P20	2		
1	AVSS0	P05	VREFL	P01	PJ5	VBATT	XCIN	XTAL	EXTAL	P33	P31	P27	PH5	PH4	P21	1		
	A	B	C	D	E	F	G	H	J	K	L	M	N	P	R			

Note: This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.5, List of Pins and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA).

Figure 1.3 Pin Assignment (177-Pin TFLGA)

	A	B	C	D	E	F	G	H	J	K	L	M	N	P	R	
15	PE2	PE3	P70	P65	P67	VSS	VCC	PG7	PA6	PB0	P72	PB4	PL0	PL1	PC1	15
14	PE1	PE0	PK4	PE7	PG3	PA0	PA1	PA2	PA7	PK7	PB1	PB5	P73	P75	P74	14
13	P63	P64	PE4	PK5	PG2	PG4	PG6	PA3	PK6	P71	PB3	PB7	PC0	PC2	P76	13
12	P60	PK3	P62	PE5	PE6	P66	PG5	PA4	PA5	PB2	PB6	P77	PC3	PC4	P80	12
11	PD6	PG1	PK2	P61	RX630 Group PLBG0176GA-A (176-Pin LFBGA) (Upper perspective view)							P81	P82	PC6	VCC	11
10	P97	PD4	PG0	PD7								PC5	PC7	P83	VSS	10
9	PK0	P96	PD3	PD5								P50	P51	P52	P84	9
8	P94	PD1	PD2	PK1								P53	PL2	PL3	PL4	8
7	VSS	P92	PD0	P95								P54	P55	VSS_USB	USB0_DP	7
6	VCC	P91	P90	P93								P56	P57	VCC_USB	USB0_DM	6
5	P46	P47	P45	P44	P13	P12	P10	P11	5							
4	P42	P41	P43	P00	VSS	BSCANP	PF4	P35	PF3	PF1	P25	P86	P15	P14	P85	4
3	VREFL0	P40	VREFH0	P03	PF5	PJ3	MD	RES#	P34	PF2	PF0	P24	P22	P87	P16	3
2	AVCC0	P07	VREFH	P02	EMLE	VCL	XCOUT	VSS	VCC	P32	P30	P26	P23	P17	P20	2
1	AVSS0	P05	VREFL	P01	PJ5	VBATT	XCIN	XTAL	EXTAL	P33	P31	P27	PH5	PH4	P21	1
	A	B	C	D	E	F	G	H	J	K	L	M	N	P	R	

Note: This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.5, List of Pins and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA).

Figure 1.4 Pin Assignment (176-Pin LFBGA)

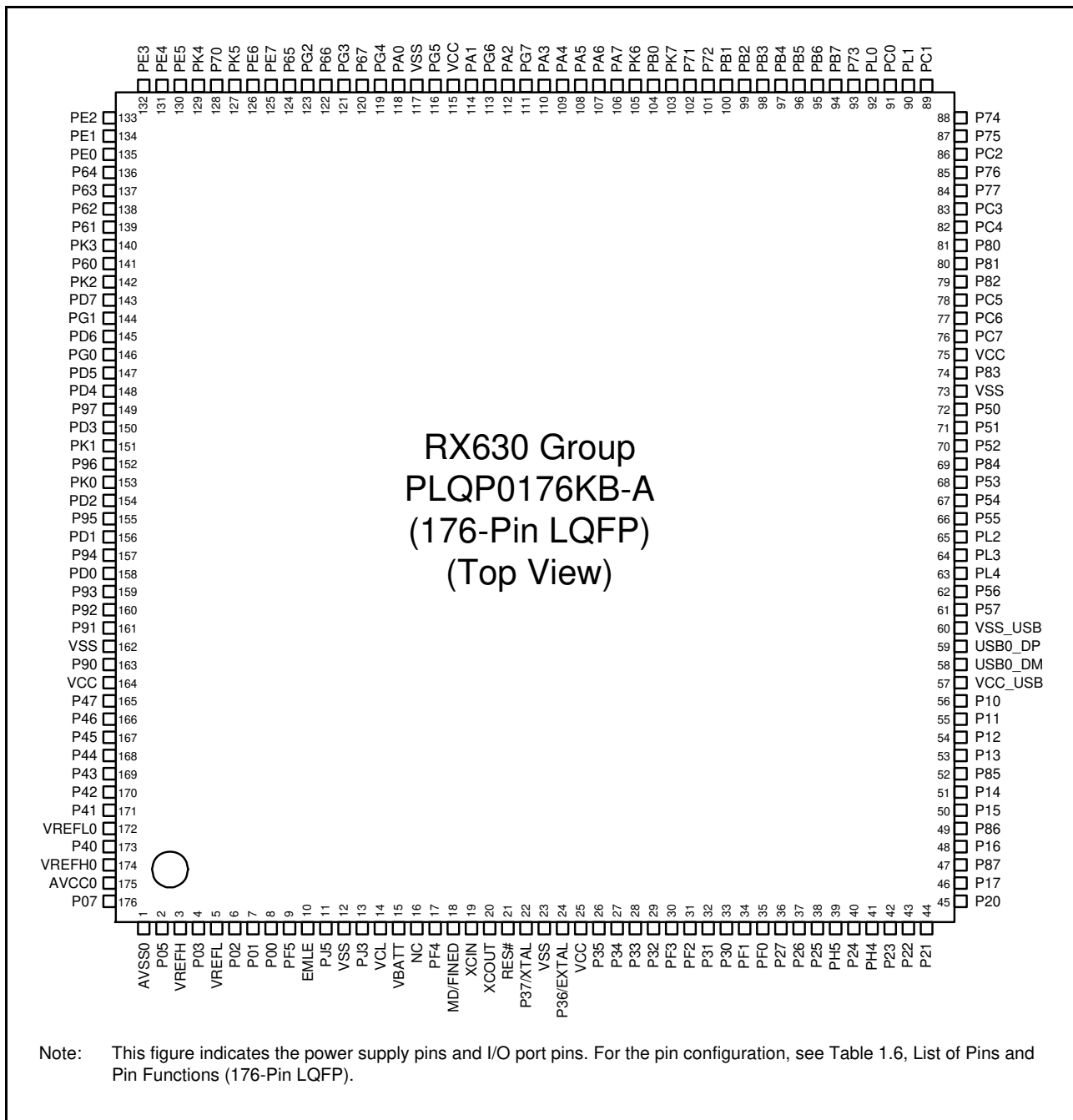


Figure 1.5 Pin Assignment (176-Pin LQFP)

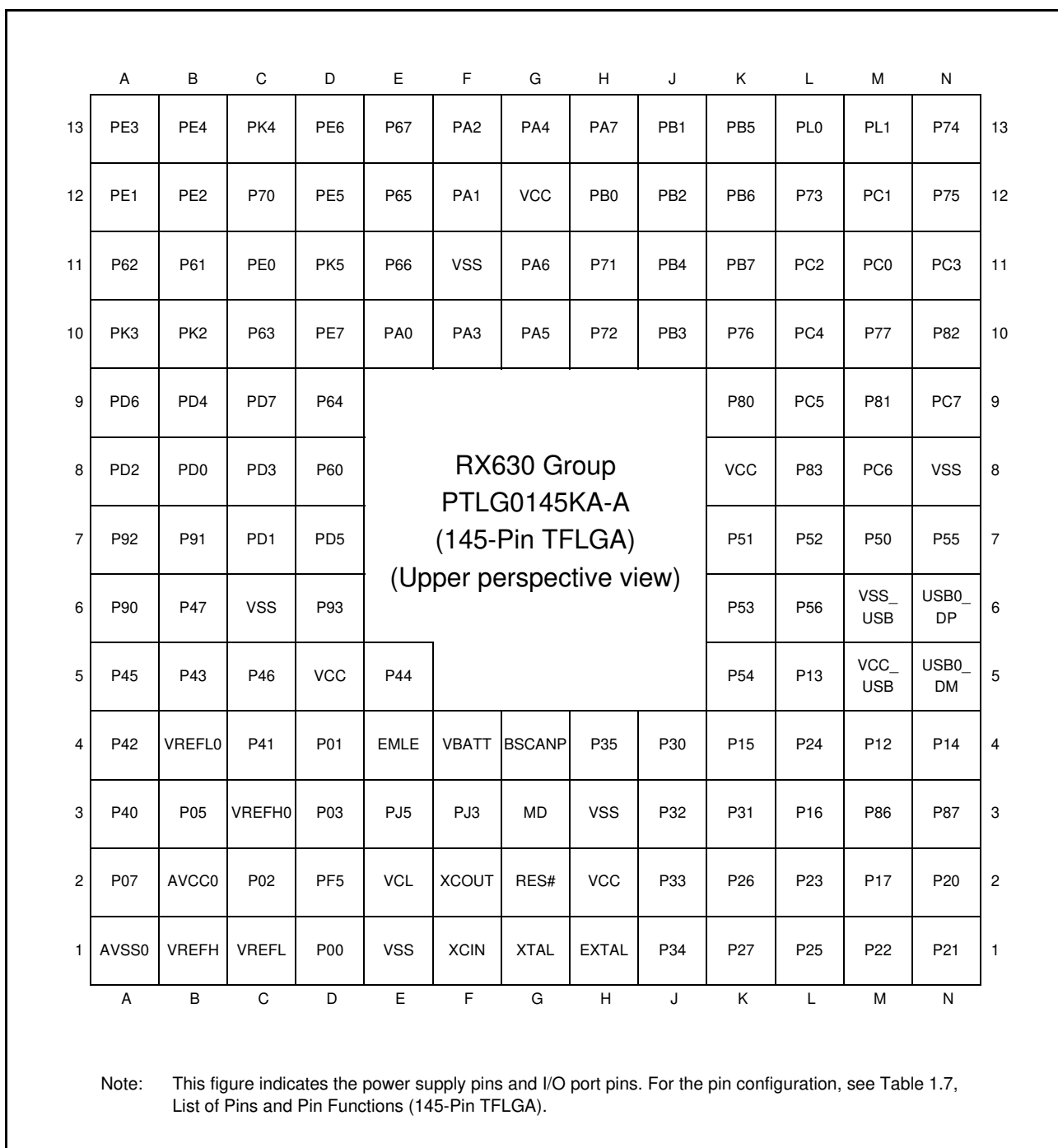


Figure 1.6 Pin Assignment (145-Pin TFLGA)

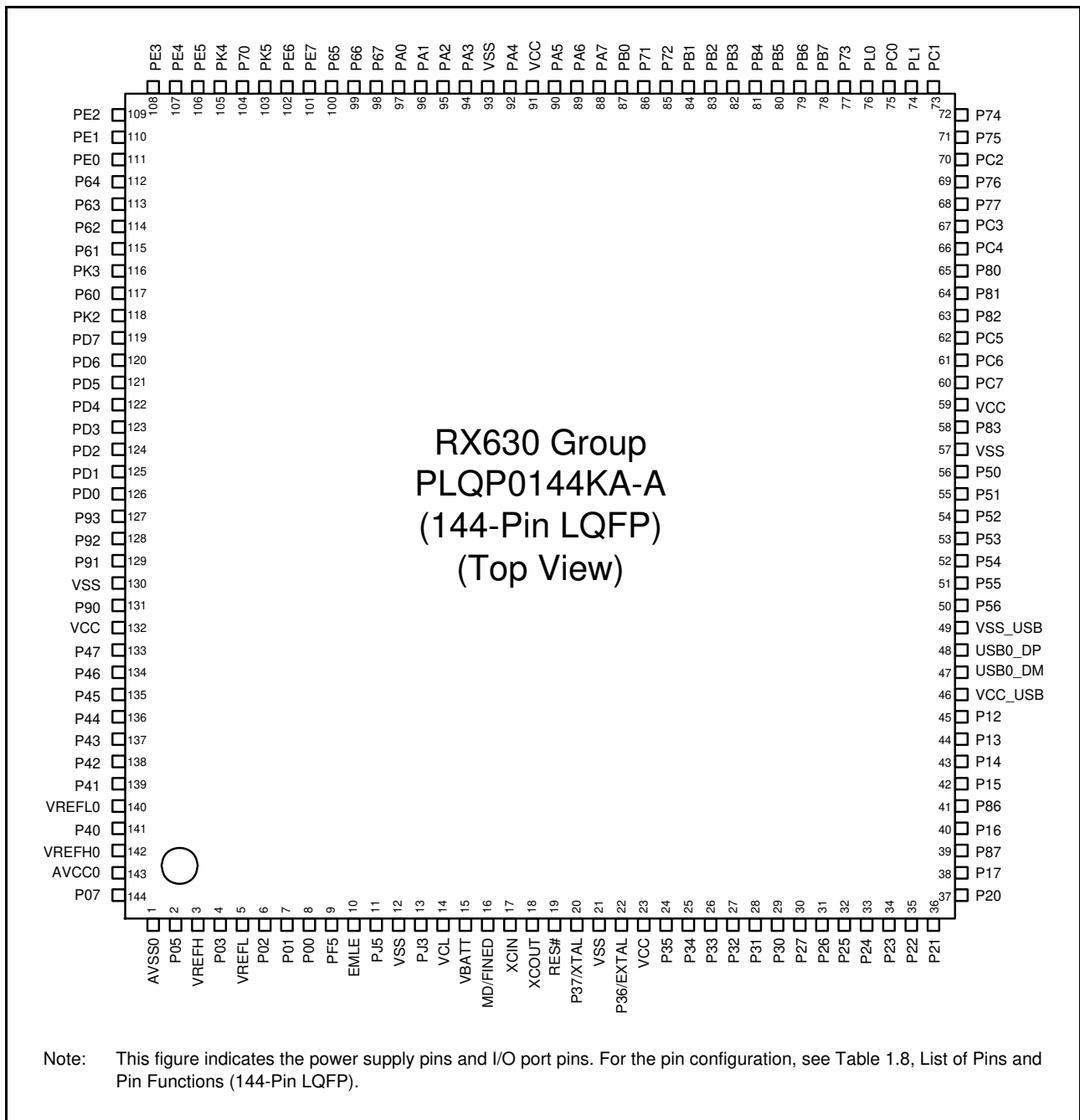


Figure 1.7 Pin Assignment (144-Pin LQFP)

**RX630 Group
PTLG0100KA-A (100-Pin TFLGA)
(Top View)**

	A	B	C	D	E	F	G	H	J	K	
10	PE2	PE3	PE4	PA0	PA3	VSS	VCC	PB7	PC1	PC2	10
9	PE1	PD7	PE5	PA1	PA5	PA7	PB1	PB6	PC0	PC3	9
8	PE0	PD6	PD5	PE7	PA4	PB0	PB4	PC6	PC4	PC5	8
7	PD4	PD3	PD2	PE6	PA6	PB2	PB5	PC7	P50	P51	7
6	PD0	PD1	P47	P46	PA2	PB3	P52	P54	VCC_ USB	USB0_ DP	6
5	P43	P44	P42	P45	P41	P12	P53	P55	VSS_ USB	USB0_ DM	5
4	VREFL0	P40	VREFH0	VBATT	P34	P32	P27	P15	P13	P14	4
3	P07	AVCC0	PJ3	MD	RES#	P35	P30	P16	P17	P20	3
2	VREFH	AVSS0	VREFL	XCOUT	VSS	VCC	P31	P25	P21	P22	2
1	P05	EMLE	VCL	XCIN	XTAL	EXTAL	P33	P26	P24	P23	1
	A	B	C	D	E	F	G	H	J	K	

Note: This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.7, List of Pins and Pin Functions (145-Pin TFLGA).

Figure 1.8 Pin Assignment (100-Pin TFLGA)

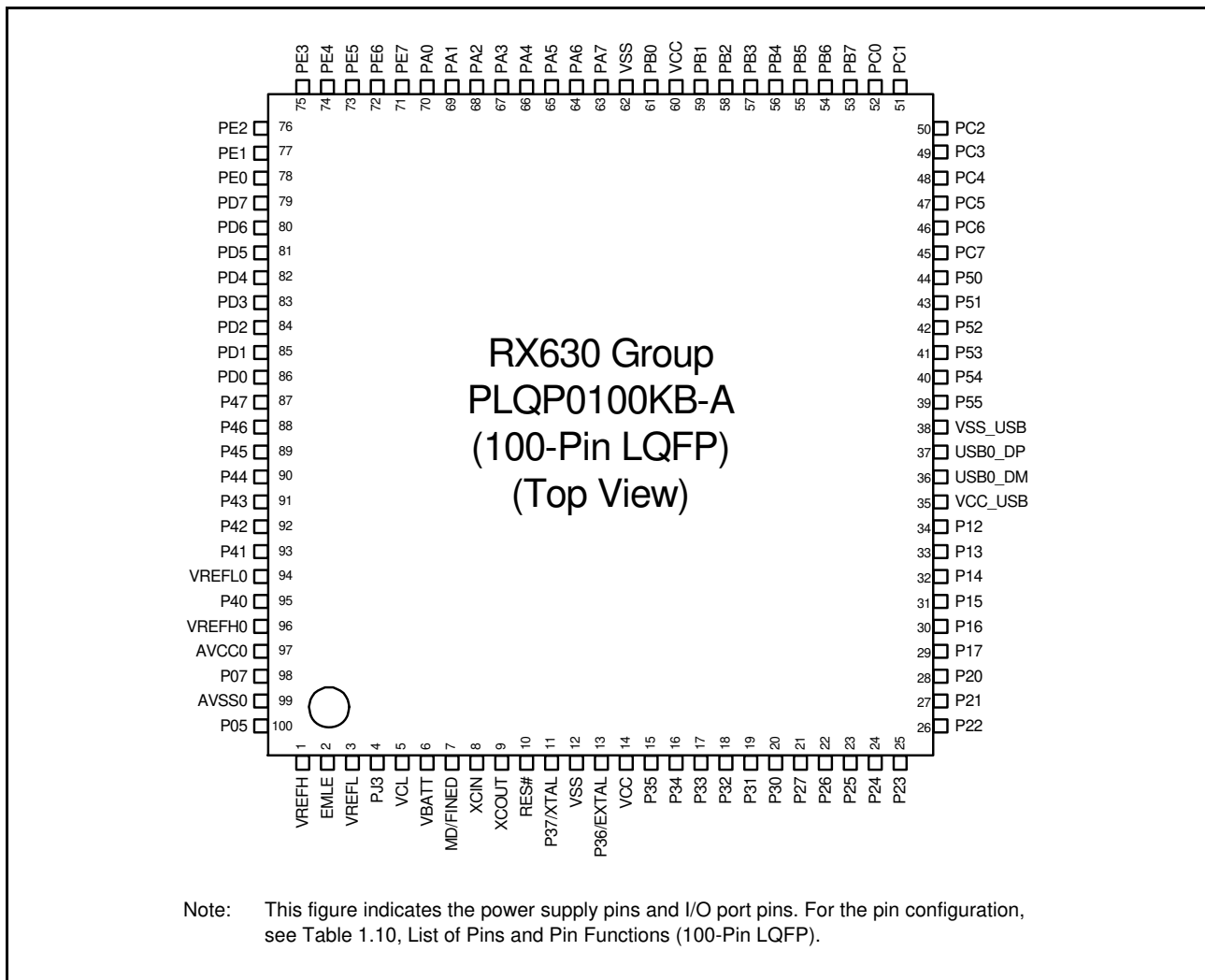


Figure 1.9 Pin Assignment (100-Pin LQFP)

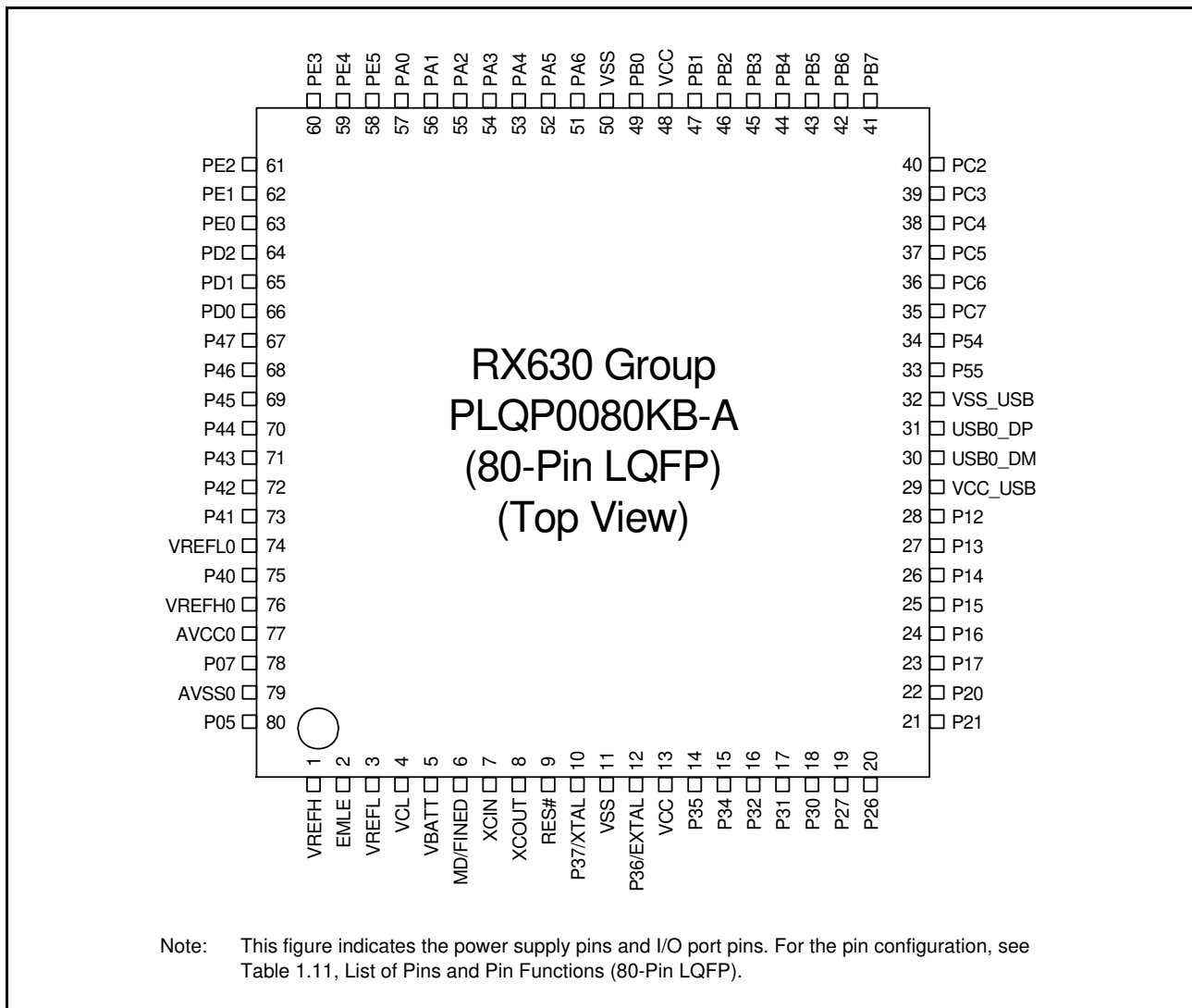


Figure 1.10 Pin Assignment (80-Pin LQFP)

Table 1.5 List of Pins and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA) (1/5)

Pin Number	Power Supply Clock System Control	I/O Port	Bus	Timer (MTU, TPU, TMR, PPG, RTC, POE)	Communications (SCiC, SCiD, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD, AD, DA
A1	AVSS0						
A2	AVCC0						
A3	VREFL0						
A4		P42				IRQ10-DS	AN002
A5		P46				IRQ14-DS	AN006
A6	VCC						
A7	VSS						
A8		P94	A20/D20				
A9		PK0					
A10		P97	A23/D23				
A11		PD6	D6[A6/D6]	MTIC5V/POE1#	SSLC2	IRQ6	AN6
A12		P60	CS0#		SCK9		
A13		P63	CS3#				
A14		PE1	D9[A9/D9]	MTIOC4C/TIOCD9/PO18	TXD12/SMOSI12/ SSDA12/TXD12/ SIOX12/SSLB2/RSPCKB		ANEX1
A15		PE2	D10[A10/D10]	MTIOC4A/TIOCA9/PO23	RXD12/SMISO12/ SSCL12/RXD12/SSLB3/ MOSIB	IRQ7-DS	AN0
B1		P05				IRQ13	DA1
B2		P07				IRQ15	ADTRG0#
B3		P40				IRQ8-DS	AN000
B4		P41				IRQ9-DS	AN001
B5		P47				IRQ15-DS	AN007
B6		P91	A17/D17		SCK7		AN015
B7		P92	A18/D18		RXD7/SMISO7/SSCL7		AN016
B8		PD1	D1[A1/D1]	MTIOC4B/TIOCB7/ TCLKG	MOSIC/CTX0	IRQ1	AN009
B9		P96	A22/D22				
B10		PD4	D4[A4/D4]	POE3#	SSLC0	IRQ4	AN012
B11		PG1	D25				
B12		PK3			RXD9/SMISO9/SSCL9		
B13		P64	CS4#				
B14		PE0	D8[A8/D8]	TIOCC9	SCK12/SSLB1		ANEX0
B15		PE3	D11[A11/D11]	MTIOC4B/TIOCB9/PO26/ POE8#	CTS12#/RTS12#/SS12#/ MISOB		AN1
C1	VREFL						
C2	VREFH						
C3	VREFH0						
C4		P43				IRQ11-DS	AN003
C5		P45				IRQ13-DS	AN005
C6		P90	A16/D16		TXD7/SMOSI7/SSDA7		AN014
C7		PD0	D0[A0/D0]	TIOCA7		IRQ0	AN008
C8		PD2	D2[A2/D2]	MTIOC4D/TIOCA8	MISOC/CRX0	IRQ2	AN010
C9		PD3	D3[A3/D3]	TIOCB8/TCLKH/POE8#	RSPCKC	IRQ3	AN011
C10		PG0	D24				
C11		PK2			TXD9/SMOSI9/SSDA9		
C12		P62	CS2#				